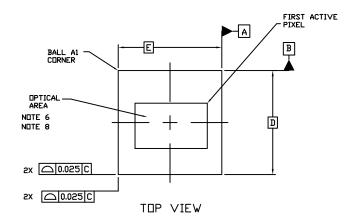


PACKAGE DIMENSIONS

ODCSP69 5.545x5.565

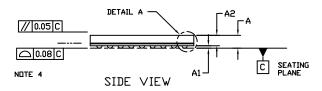
CASE 570BV ISSUE B

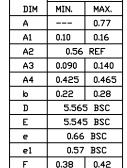
DATE 02 MAY 2018



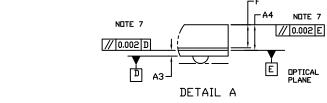
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION 6 IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO DATUM C.
- COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPERICAL CROWNS OF THE SOLDER BALLS.
- 6. MAXIMUM ROTATION OF OPTICAL AREA RELATIVE TO D AND E WILL BE 0.1*. OPTICAL AREA IS DEFINED BY THE ACTIVE PIXEL ARRAY. REFER TO THE DEVICE DATASHEET FOR TOTAL ARRAY AND FIRST ACTIVE PIXEL DEFINITIONS.
- 7. PARALLELISM APPLIES ONLY TO THE OPTICAL AREA.
- 8. OPTICAL CENTER OFFSET WITH RESPECT TO THE PACKAGE CENTER IS X=62 MICRONS, Y=-171 MICRONS ±25 MICRONS.





MILLIMETERS



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DESCRIPTION:	ODCSP69 5.545x5.565		PAGE 1 OF 1

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